

Part Number: XZMOKT53W-6

1.6x0.8x0.25mm (0603) SMD CHIP LED LAMP

Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 4,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- RoHS compliant





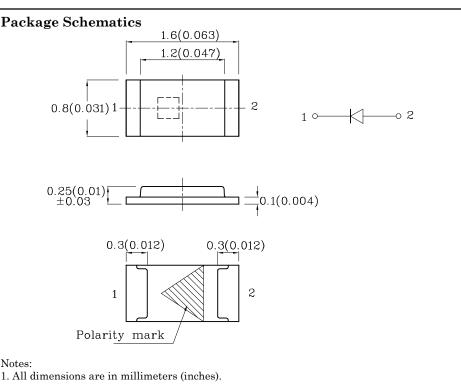
DEVICES

Applications

1.Mobile phone Keypad indicator and backlight

2.Flat backlight for LCD, switch and symbol

3.Toys



- 2. Tolerance is $\pm 0.1(0.004")$ unless otherwise noted.
- 3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Orange (AlGaInP)	Unit	
Reverse Voltage	V_{R}	5	V	
Forward Current	$\mathbf{I}_{\mathbf{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	\mathbf{P}_{D}	75	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	-40 ~ +85	C	

ATTENTION

FOR HANDLING

ELECTROSTATIC DISCHARGE SENSITIVE

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Orange (AlGaInP)	Unit	
Forward Voltage (Typ.) (I _F =20mA)	V_{F}	2.05	V	
Forward Voltage (Max.) (I _F =20mA)	V_{F}	2.5	V	
Reverse Current (Max.) (V _R =5V)	I_R	10	μΑ	
Wavelength of Peak Emission CIE127-2007*(Typ.) (I _F =20mA)	λP	610*	nm	
Wavelength of Dominant Emission CIE127-2007*(Typ.) (I _F =20mA)	λD	601*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =20mA)	$ riangle\lambda$	17	nm	
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	15	pF	

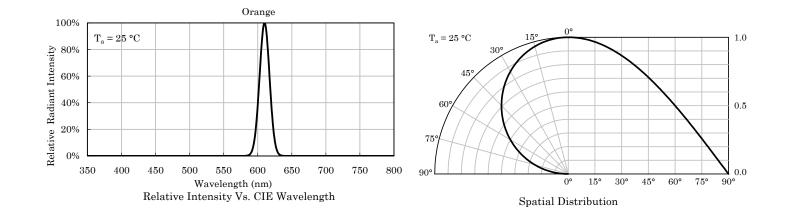
Part Number	Emitting Color	Emitting Material	Lens-color	Luminous Intensity CIE127-2007* (I _F =20mA) mcd		Wavelength CIE127-2007* nm λP	Viewing Angle 20 1/2
				min.	typ.		
XZMOKT53W-6	Orange	AlGaInP	Water Clear	120 55*	297 98*	610*	120°

*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

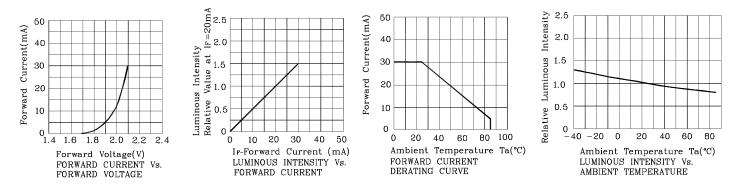
Feb 28,2019

XDSB2081 V8-X Layout: Maggie L.

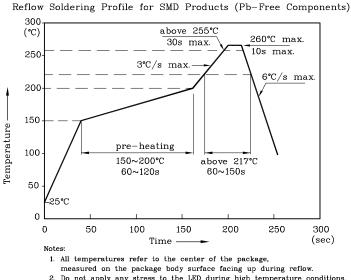




Orange



LED is recommended for reflow soldering and soldering profile is shown below.

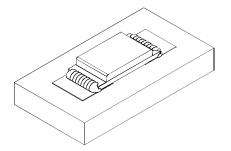


Do not apply any stress to the LED during high temperature conditions. Maximum number of soldering passes: 2 З.

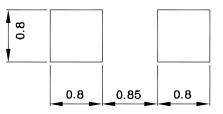
XDSB2081 V8-X Layout: Maggie L.



✤ The device has a single mounting surface. The device must be mounted according to the specifications.

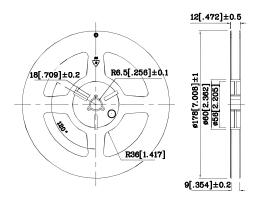


Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

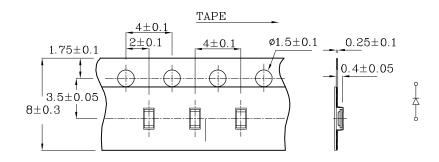


Mask open area ratio:80% Mask thickness:80~100um

Reel Dimension



Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

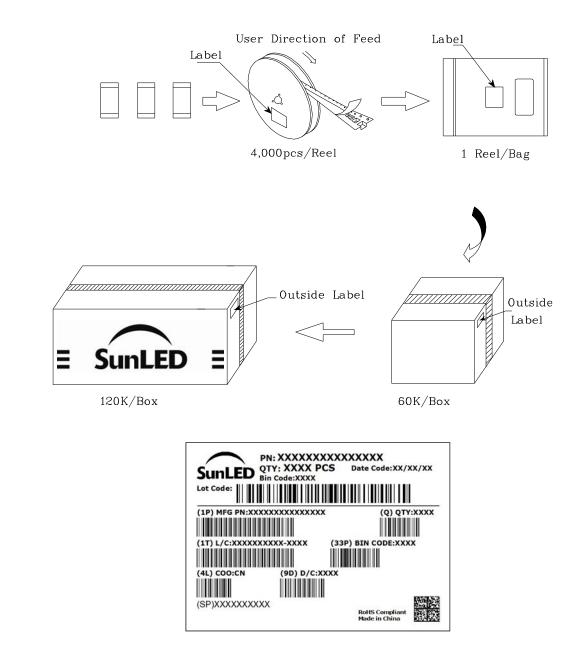
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V $\,$

Note: Accuracy may depend on the sorting parameters.



PACKING & LABEL SPECIFICATIONS



TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
- 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
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- 6. Additional technical notes are available at <u>https://www.SunLEDusa.com/TechnicalNotes.asp</u>